

$V_{RSM}$	$I_{FAV}$ (sin. 180; $T_{case} = \dots$ )	
$V$	4000 A (50 °C)	6000 A (85 °C)
200	<b>SKN 4000/02</b>	<b>SKN 6000/02</b>
400	<b>SKN 4000/04</b>	<b>SKN 6000/04</b>
600	<b>SKN 4000/06</b>	<b>SKN 6000/06</b>

## Rectifier Diodes

**SKN 4000**  
**SKN 6000**



Symbol	Conditions	SKN 4000	SKN 6000	Units
$I_{FAV}$	sin. 180; $T_{case} = 50$ °C; DSC <sup>1)</sup> 85 °C; DSC <sup>1)</sup> 100 °C; DSC <sup>1)</sup>	4 000 3 200 2 740	6 000 5 400	A A A
$I_{FSM}$	$T_{vj} = 25$ °C; 10 ms $T_{vj} = 180$ °C; 10 ms		60 50	kA kA
$i^2t$	$T_{vj} = 25$ °C; 8,3 ... 10 ms $T_{vj} = 180$ °C; 8,3 ... 10 ms		18 000 12 500	kA <sup>2</sup> s kA <sup>2</sup> s
$I_R$	$T_{vj} = 25$ °C; $V_R = V_{RRM}$ $T_{vj} = 180$ °C; $V_R = V_{RRM}$		4 100	mA mA
$V_F$ $V_{(TO)}$ $r_T$	$T_{vj} = 25$ °C; $I_F = 14$ kA; max. $T_{vj} = 180$ °C $T_{vj} = 180$ °C		1,3 <sup>2)</sup> 0,7 0,04	V V mΩ
$R_{thjc}$	DSC <sup>1)</sup> SSC <sup>1)</sup>	0,030 0,060	0,012 0,024	°C/W °C/W
$R_{thch}$	DSC <sup>1)</sup> SSC <sup>1)</sup>		0,005 0,010	°C/W °C/W
$T_{vj}$ $T_{stg}$			– 40 ... + 180 – 40 ... + 150	°C °C
$F$	SI units US units		24 ... 30 5400 ... 6750	kN lbs.
$w$		129	130	g
Case		E 35		

## Features

- Capsule type metal-ceramic packages with precious metal pressure contacts
- Medium voltage, high current rectifier diodes with slim package for lowest thermal resistance. Low power dissipation. Especially suited for water cooling. Forward selections for paralleling available

## Typical Applications

- Welding
- Electroplating

<sup>1)</sup> DSC = double sided cooling  
SSC = single sided cooling

<sup>2)</sup> For parallel connections selected devices are available on request

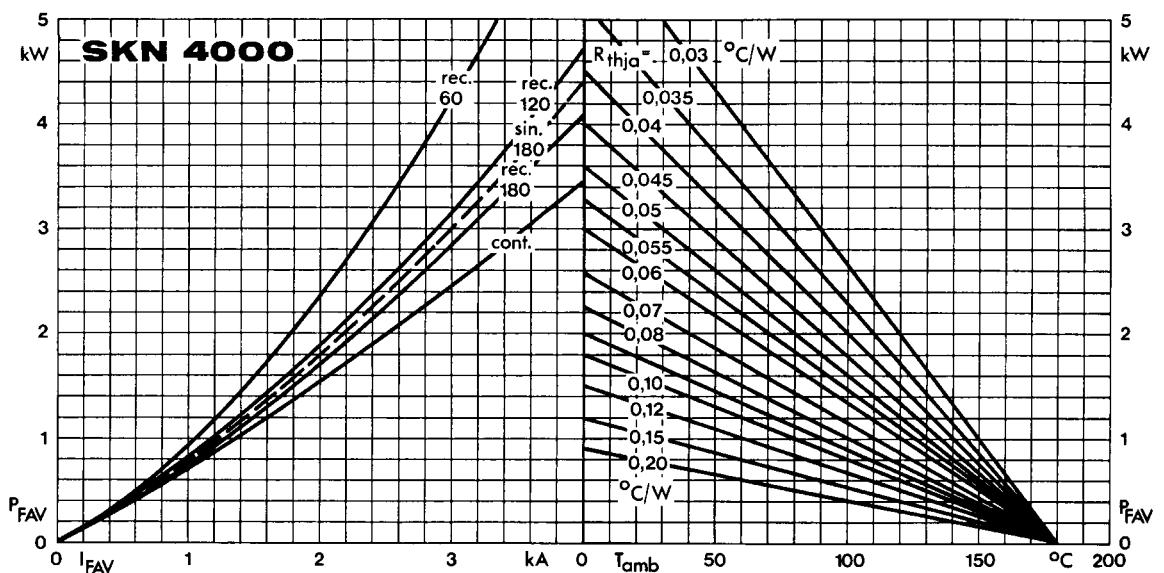


Fig. 2 a Power dissipation vs. forward current and ambient temperature

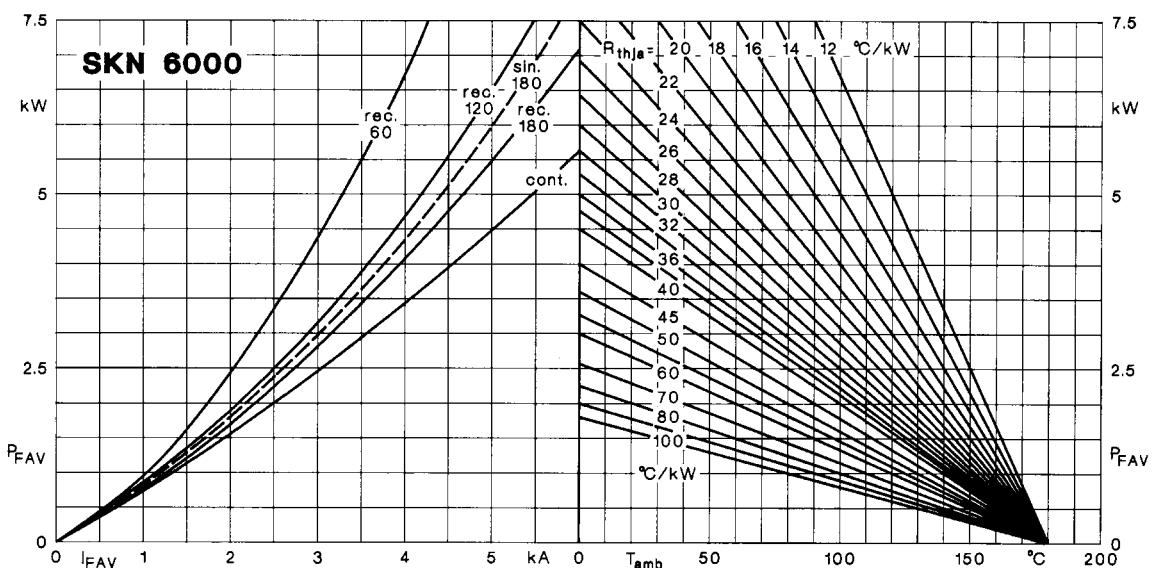


Fig. 2 b Power dissipation vs. forward current and ambient temperature

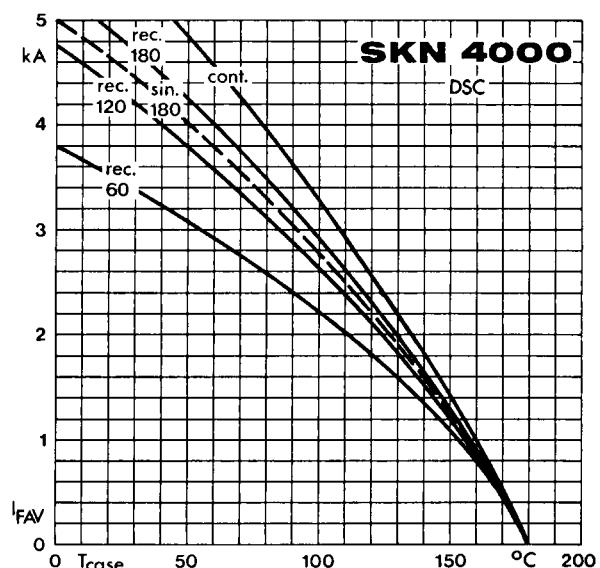


Fig. 3 a Rated forward current vs. case temperature

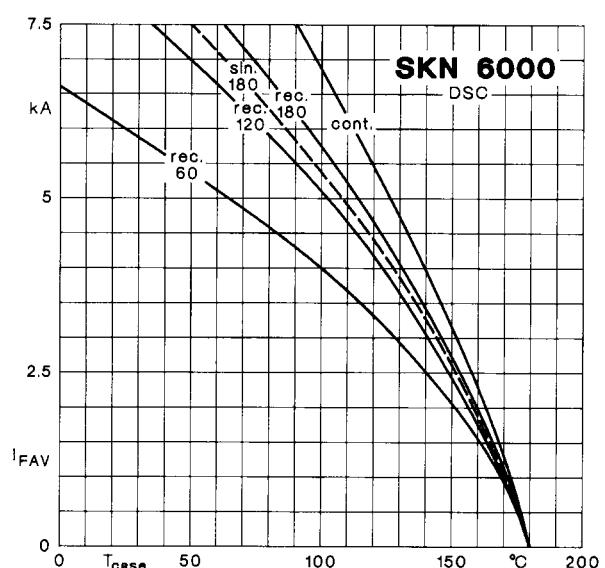


Fig. 3 b Rated forward current vs. case temperature

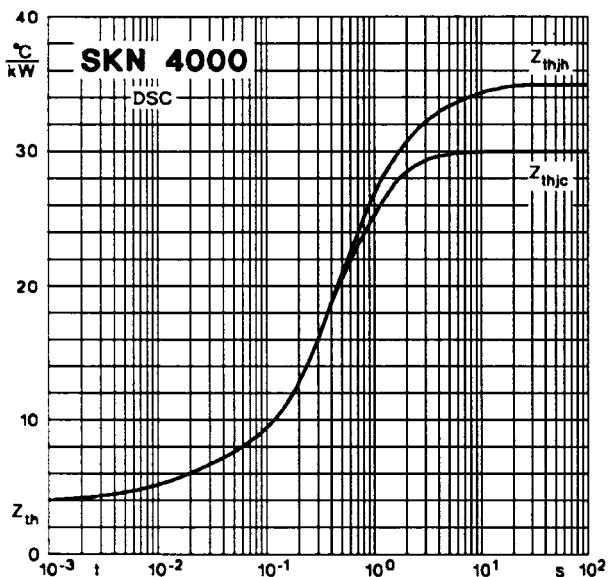


Fig. 5 a Transient thermal impedance vs. time

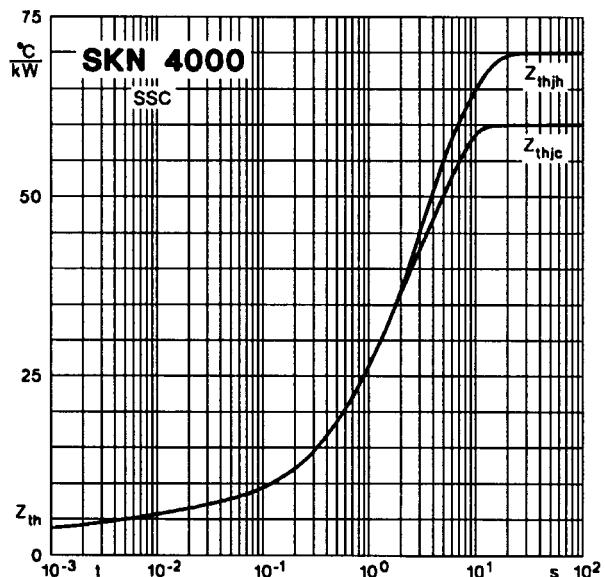


Fig. 5 b Transient thermal impedance vs. time

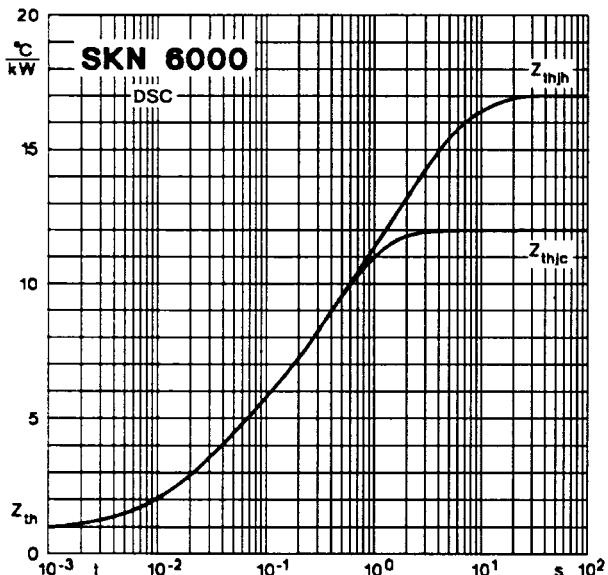


Fig. 5 c Transient thermal impedance vs. time

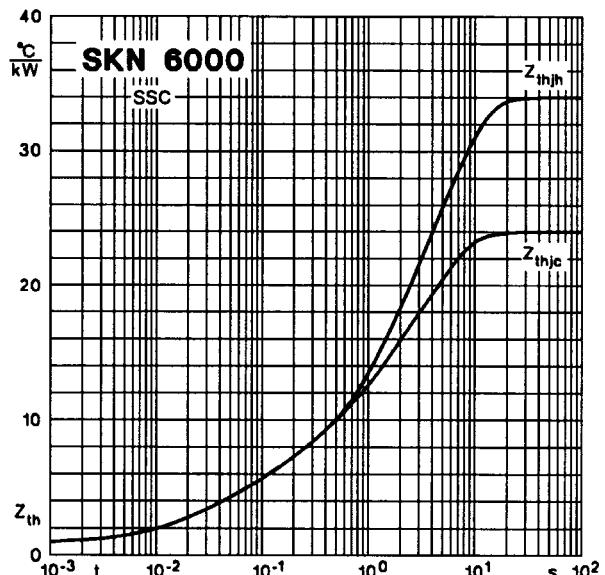


Fig. 5 d Transient thermal impedance vs. time

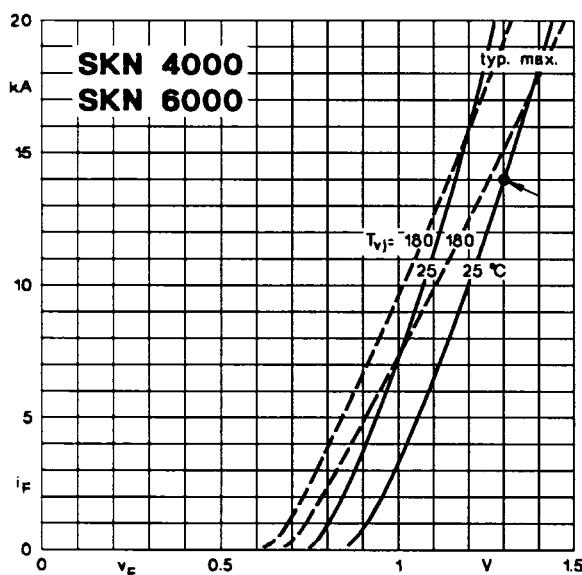


Fig. 6 Forward characteristics

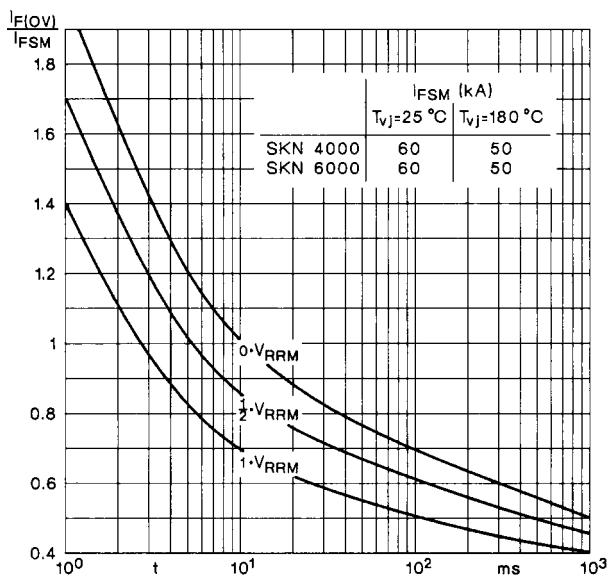


Fig. 7 Surge overload current vs. time

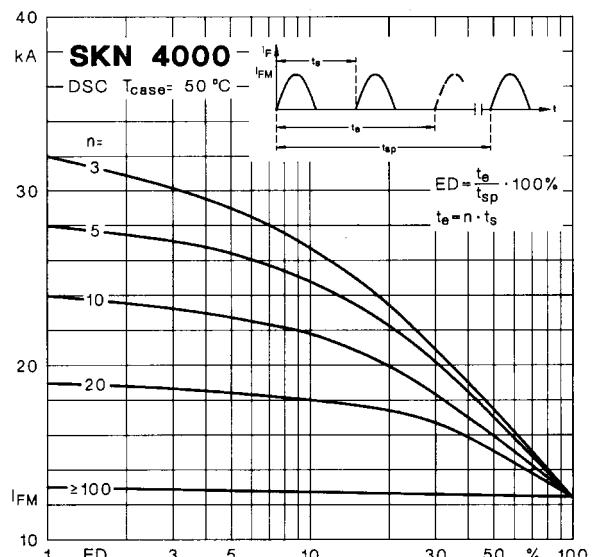


Fig. 12 a Rated peak forward current vs. duty cycle

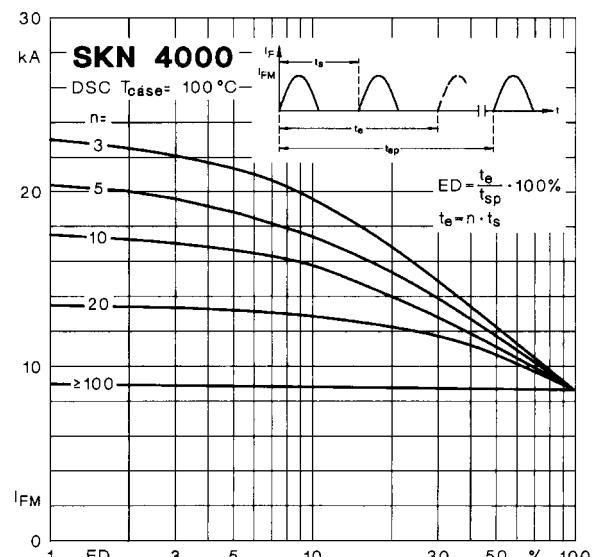


Fig. 12 b Rated peak forward current vs. duty cycle

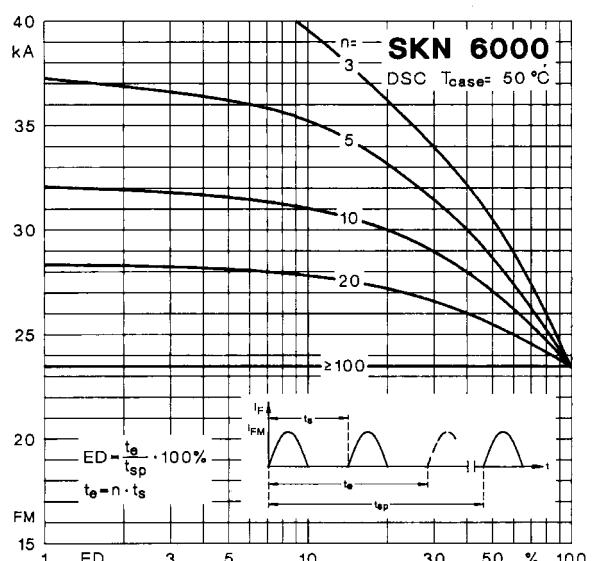


Fig. 12 c Rated peak forward current vs. duty cycle

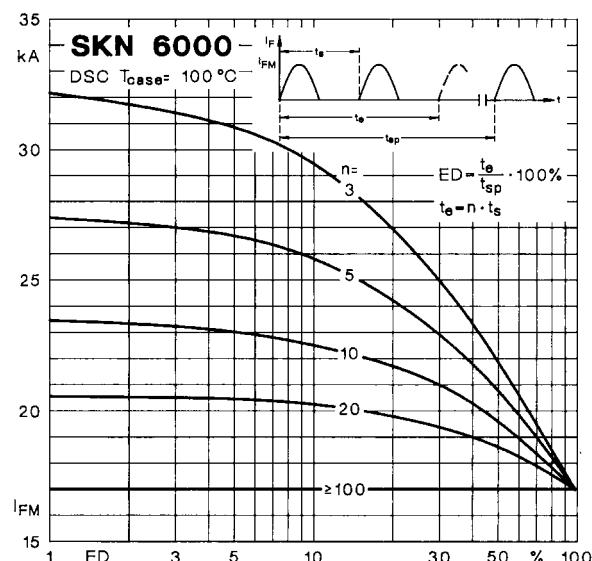


Fig. 12 d Rated peak forward current vs. duty cycle

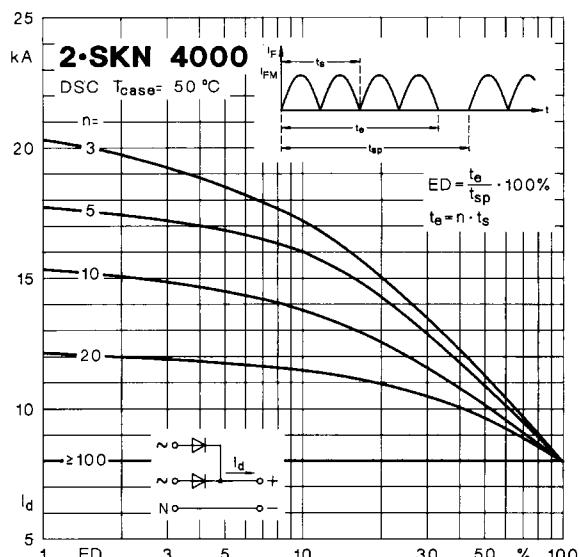


Fig. 13 a Rated direct output current vs. duty cycle

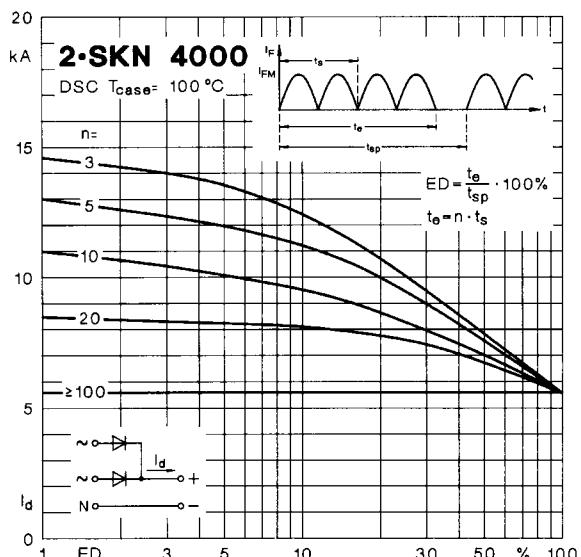


Fig. 13 b Rated direct current vs. duty cycle

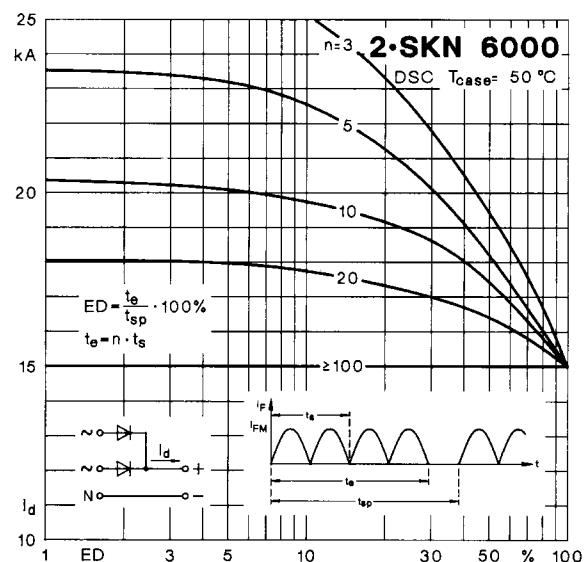


Fig. 13 c Rated direct output current vs. duty cycle

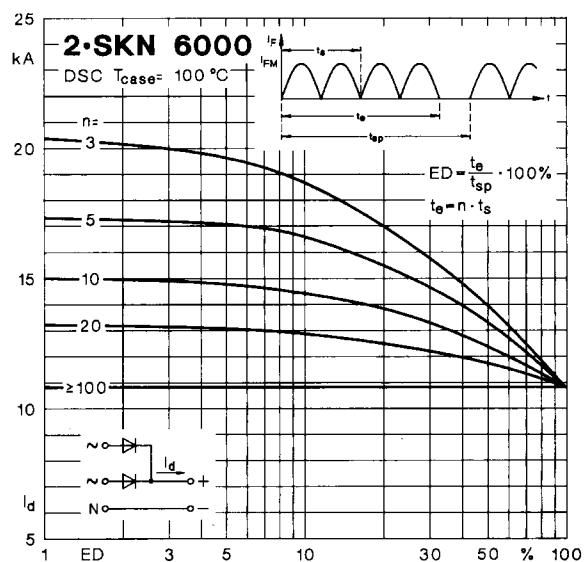
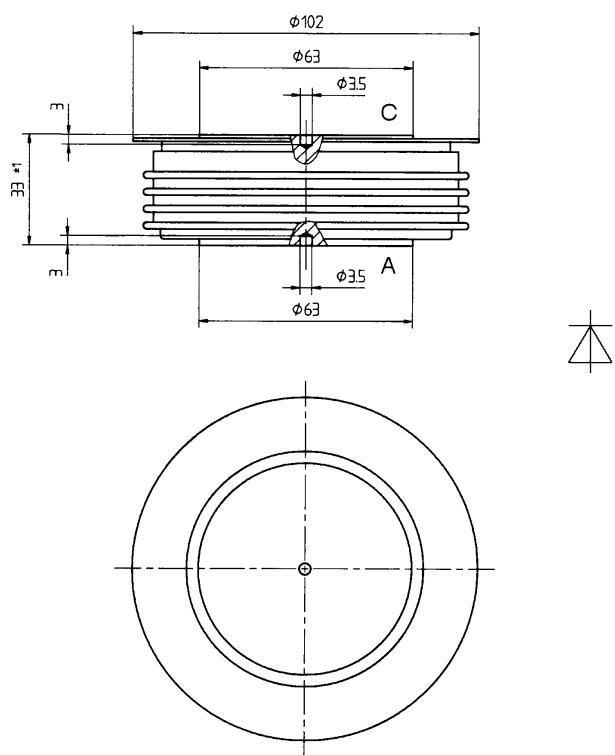


Fig. 13 d Rated direct current vs. duty cycle

**SKN 3000****SKN 3400**

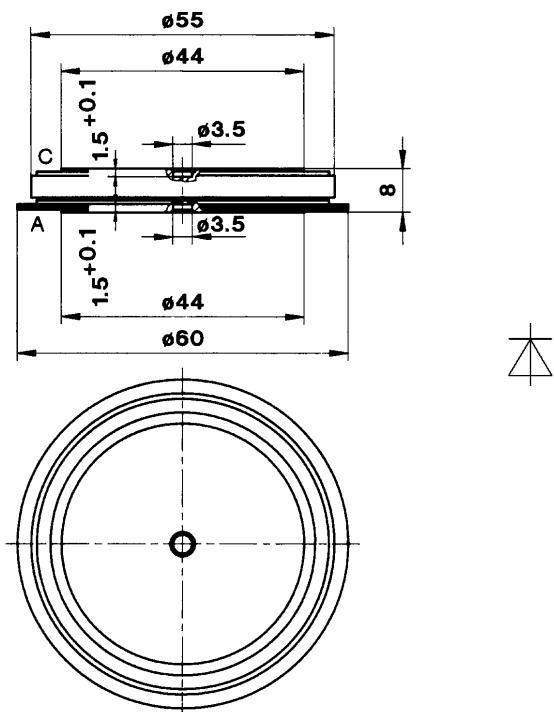
Case E 37



Dimensions in mm

**SKN 4000****SKN 6000**

Case E 35



Dimensions in mm